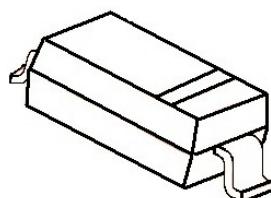


SOD-323**Marking: L9**
SOD-323 贴片塑封肖特基二极管
SOD-323 Plastic-Encapsulate Schottky Barrier Diode
特征 Features

- 大电流承受能力。High Current Capability
- 正向压降低。Low Forward Voltage Drop

机械数据 Mechanical Data

- 封装: SOD-323 封装 SOD-323 Small Outline Plastic Package
- 极性: 色环端为负极 Polarity: Color band denotes cathode end
- 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

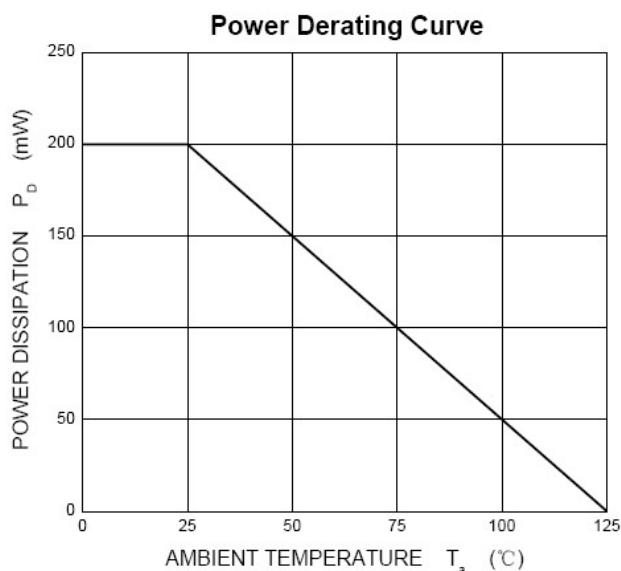
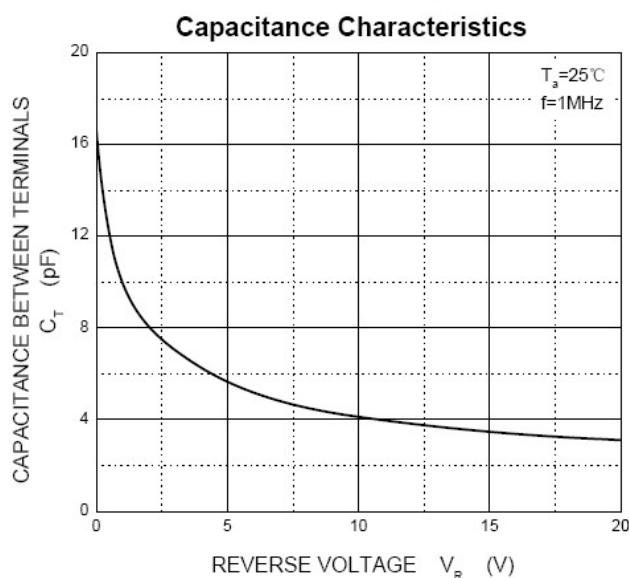
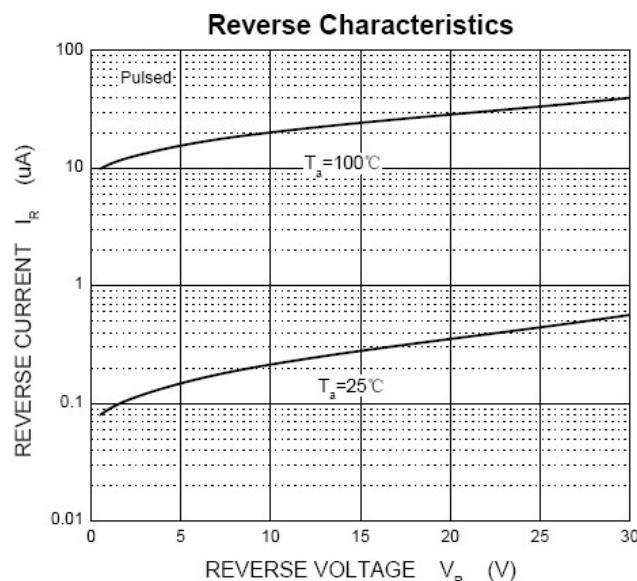
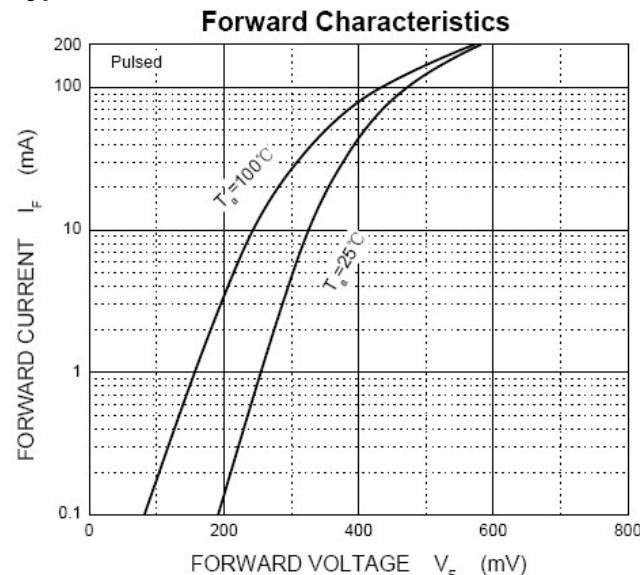
极限值和温度特性($TA = 25^\circ\text{C}$ 除非另有规定)**Maximum Ratings & Thermal Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	界限 Limit	单位 Unit
最大可重复峰值反向电压 Maximum repetitive peak reverse voltage	VRRM	30	V
最大均方根电压 Maximum RMS voltage	VRMS	21	V
最大直流阻断电压 Maximum DC blocking voltage	VDC	30	V
最大正向平均整流电流 Maximum average forward rectified current	IFM	300	mA
峰值正向浪涌电流 8.3ms 单一正弦半波 Peak forward surge current 8.3 ms single half sine-wave	IFSM	600	mA
典型热阻 Typical thermal resistance	R _{θJA}	500	°C/W
功率消耗 Power Dissipation	PD	200	mW
结温 Junction Temperature	T _J	125	°C
存储温度 Storage temperature range	T _{STG}	-50~+150	°C

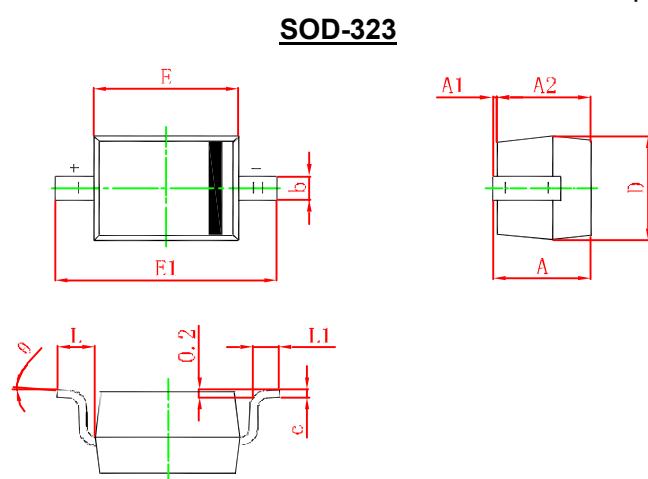
电特性 ($TA = 25^\circ\text{C}$ 除非另有规定)**Electrical Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	测试条件 Test conditions	Min	Typ	Max	单位 Unit
最大正向电压 Maximum forward voltage	VF1	IF = 0.1mA			240	mV
	VF2	IF = 1.0mA			320	
	VF3	IF = 10mA			400	
	VF4	IF = 30mA			500	
	VF5	IF = 100mA			1000	
最大反向电压 Maximum reverse breakdown voltage	VR	IR=100uA	30			V
最大反向电流 Maximum reverse current	IR	VR=25V			2.0	uA
典型结电容 Type junction capacitance	C _j	VR = 1.0V, f = 1MHz			10	pF
反向恢复时间 Reverse Recovery Time	T _{rr}	IF=10mA, VR=6V, IR=10mA			6	nS

Typical Characteristics



SOD-323 PACKAGE OUTLINE Plastic surface mounted package



Symbol	Min.(mm)	Max.(mm)
A		1.000
A1	0.000	0.100
A2	0.800	0.900
b	0.250	0.350
c	0.080	0.150
D	1.200	1.400
E	1.600	1.800
E1	2.500	2.700
L	0.475REF	
L1	0.250	0.400
θ	0°	8°